## In the Claims:

1. (Currently Amended) A photosensitive resin composition <u>consisting</u>

<u>essential of eomprising</u> a self-curable binder resin, <u>a crosslinking compound having at</u>

<u>least two ethylenically unsaturated bonds</u>, a photopolymerization initiator, and a solvent,

wherein the self-curable binder resin <u>comprises compounds A Band C wherein A has</u>

<u>eompound represented in the following Chemical Formula formula</u> 1:

[Chemical Formula 1] A B C

where A is a compound represented as in the following Chemical Formula formula: -A;

## [Chemical Formula 1-A]

$$\begin{array}{c}
R_1 \\
0 \\
OH
\end{array}$$

; where in B is a compound represented as in has the following Chemical Formula formula: 1-B;

[Chemical Formula 1-B]
$$R_1 \longrightarrow 0$$

$$R$$

; wherein C is a compound represented as in has the following Chemical Formula formula selected from the group consisting of 1-C and/or Chemical Formula 1-C';

[Chemical Formula 1-C]

$$\begin{array}{c}
R_1 \\
0 \\
0 \\
R_2
\end{array}$$

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(1-C)

[Chemical Formula 1-C']

<u>and</u>

$$\begin{array}{c} R_1 \\ \hline R_3 \end{array} \tag{1-C'}$$

further; wherein  $R_1$  is H or -CH<sub>3</sub>,  $R_2$  is an alkyl group having 1 to 8 carbon atoms, a hydroxyl group, substituted alkyl group, or a substituted or unsubstituted aryl group having 1 to 12 carbon atoms, and  $R_3$  is a benzene, an alkyl group having 1 to 8 carbon atoms, an alkoxy group having 1 to 8 carbon atoms, a benzene having a  $C_1 \sim C_6$  alkyl substituent, a benzene having a  $C_1 \sim C_8$  alkoxy substituent, or a hydroxide group or halogen substitute benzene.

- 2. (Currently Amended) A photosensitive resin composition in accordance with claim 1, wherein an compound A is present from about portion in a binder resin of the Chemical Formula 1 accounts for 10 to 50 mol%, compound B is present up to about portion amounts for 0 to 15 mol%, and compound a C is portion accounts for 90 to 50 mol% present from about 50 to 90 mol% based on the total binder resin.
- 3. (Currently Amended) A photosensitive resin composition in accordance with claim 1, wherein the self-curable binder resin is a self-curable binder resin obtained by reacting a copolymer which is prepared by copolymerizing a compound of the formula  $CH_2 = (R_1) COOH(2)$  with one or both of a compound of the formula  $CH_2 = (CR_1) COOR_2(3)$  and  $CH_2 C(R_1) R_3(4)$  following Chemical Formula 3 and a compound of the NY02:462257.1

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following Chemical Formula 4-with a compound of the formula following Chemical Formula 5:

[Chemical Formula 2]

 $CJ_2=C(R_1)COOH$ 

[Chemical Formula 3]

 $CH_2=C(R_1-COOR_2)$ 

[Chemical Formula 4]

 $CH_2=C(R_4)-R_3$ 

[Chemical Formula 5]

wherein  $R_1$  is hydrogen or a methyl group,  $R_2$  is a compound selected from the group consisting of an alkyl group having 1 to 8 carbon atoms, a hydroxy group substitute alkyl group, and a substituted or unsubstituted aryl group or arylalkyl group 4 to 12 carbon atoms, and  $R_3$  is a compound selected from the group consisting of a benzene, an alkyl group having 1 to 8 carbon atoms, an alkoxy group having 1 to 8 carbon atoms, a benzene having a  $C_1 \sim C_8$  alkyl substituent, a benzene having a  $C_1 \sim C_6$  alkoxy substituent, and a hydroxide group or halogen substitute benzene.

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4. (Currently Amended) A photosensitive resin composition in accordance with claim 3, wherein a compound (2) of the Chemical Formula 2 comprising the eopolymer is acrylic acid or methacrylic acid, a compound of the Chemical Formula (3)

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is a compound selected from the group consisting of benzyl(meth)acrylate, phenyl(meth)acrylate, cyclohexyl(meth)acrylate, methy(meth)acrylate, ethyl(meth)acrylate, and 2-ethylhexy(meth)acrylate, and a compound of the Chemical Formula (4) is a compound selected from the group consisting of styrene, 4-hydroxystyrene, 4-methylstyrene, and vinyl acetate.

- 5. (Currently Amended) A photosensitive resin composition in accordance with claim 3, wherein a compound of the Chemical Formula (5) is glycidyl acrylate or glycidyl methacrylate.
- 6. (Currently Amended) A photosensitive resin composition in accordance with claim 3, a number average molecular weight wherein the copolymer-has a molecular weight of the copolymer is from about 1,000 to about 100,000.
- 7. (Currently Amended) A photosensitive resin composition in accordance with claim 3, wherein a compound (5) is present in an amount of the Chemical Formula 5 is from 0.1 to 90 mol% based on a carboxylic acid containing monomer of Chemical Formula compound (2) in a the binder resin of A, B and C Chemical Formula 1
- 8. (Currently Amended) A photosensitive resin composition in accordance with claim 3, wherein a compound (2) amount of the Chemical Formula 5 is present from about 10 to 90 mol% based on the mole sum of formulae Chemical Formulae 2, 3, (2), (3), and 4 (4).

9 to 16. (Cancelled)